

October 2013

RURG3060CC_F085 30A, 600V Ultrafast Rectifier

Features

- High Speed Switching (t_{rr}=60ns(Typ.) @ I_F=30A)
- Low Forward Voltage(V_F=1.5V(Max.) @ I_F=30A)
- · Avalanche Energy Rated
- · AEC-Q101 Qualified

Applications

- · Automotive DCDC converter
- · Automotive On Board Charger
- · Switching Power Supply
- · Power Switching Circuits

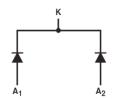
30A, 600V Ultrafast Rectifier

The RURG3060_F085 is an dual ultrafast diode with soft recovery characteristics (trr<80ns). It has low forward voltage drop and is silicon nitride passivated ionimplanted epitaxial planar construction.

This device is intended for use as a freewheeling/clamping diode and rectifier in a variety of switching power supplies and other power switching applications. Its low stored charge and ultrafast recovery with soft recovery characteristic minimizes ringing and electrical noise in many power switching circuits, thus reducing power loss in the switching transistors.

Pin Assignments





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
V _{RRM}	Peak Repetitive Reverse Voltage	600	V	
V _{RWM}	Working Peak Reverse Voltage	600	V	
V _R	DC Blocking Voltage	600	V	
I _{F(AV)}	Average Rectified Forward Current @ T _C = 25°C	30	Α	
I _{FSM}	Non-repetitive Peak Surge Current (Halfwave 1 Phase 50Hz)	90	А	
E _{AVL}	Avalanche Energy (1A, 40mH)	20	mJ	
T _{J,} T _{STG}	Operating Junction and Storage Temperature	- 55 to +175	°C	

Thermal Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter	Max	Units	
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case (Single Anode)	1	°C/W	
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	45	°C/W	

Package Marking and Ordering Information

Device Marking	Device	Package	Tube	Quantity	
RURG3060CC RURG3060CC_F085		TO-247	•	30	

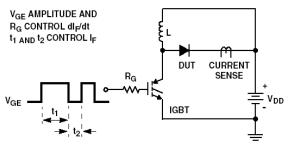
Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted, for Single anode

Symbol	Parameter	Conditions		Min.	Тур.	Max	Units
I _R	Instantaneous Reverse Current	V _R = 600V	T _C = 25 °C	-	-	250	uA
			T _C = 175 °C	-	-	1	mA
V _{FM} ¹	Instantaneous Forward Voltage	I _F = 30A	T _C = 25 °C T _C = 175 °C	-	1.26 1.06	1.5 1.3	V
t _{rr} ²	Reverse Recovery Time	I_F =1A, di/dt = 100A/ μ s, V_{CC} = 390V	T _C = 25 °C	-	35	55	ns
		I_F =30A, di/dt = 100A/ μ s, V_{CC} = 390V	T _C = 25 °C T _C = 175 °C	-	60 231	80 -	ns ns
t _a t _b Q _{rr}	Reverse Recovery Time Reverse Recovery Charge	$I_F = 30A$, di/dt = 100A/ μ s, $V_{CC} = 390V$	T _C = 25 °C	- - -	31 29 92	- - -	ns ns nC
E _{AVL}	Avalanche Energy	I _{AV} =1.0A,L = 40mH	•	20	-	-	mJ

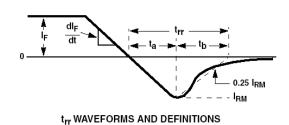
Notes

- 1. Test Pulse Width = 300us, Duty Cycle = 3%
- 2 Guaranteed by design.

Test Circuit and Waveforms



trr TEST CIRCUIT



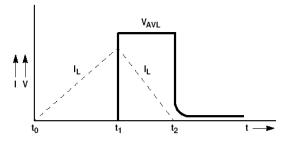
I_{MAX} = 1A L = 40mH R < 0.1Ω E_{AVL} = 1/2LI² [V_{R(AVL)}/(V_{R(AVL)} - V_{DD})] Q₁ = IGBT (BV_{CES} > DUT V_{R(AVL)}) CURRENT SENSE

V_{DD}

V_{DD}

V_{DD}

AVALANCHE ENERGY TEST CIRCUIT



AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

Typical Performance Characteristics Single Anode

Figure 1. Typical Forward Voltage Drop vs. Forward Current

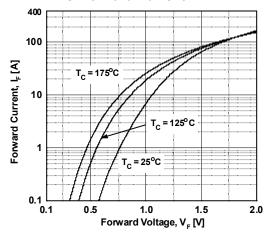


Figure 3. Typical Junction Capacitance

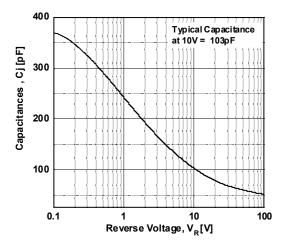


Figure 5. Typical Reverse Recovery Current vs. di/dt

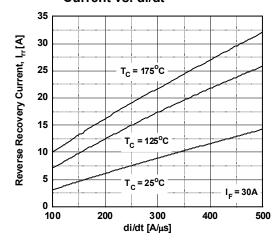


Figure 2. Typical Reverse Current vs. Reverse Voltage

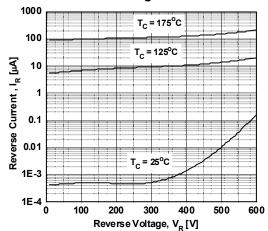


Figure 4. Typical Reverse Recovery Time vs. di/dt

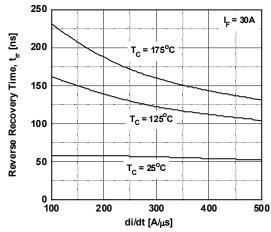
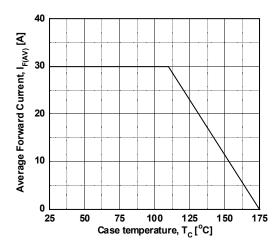


Figure 6. Forward Current Derating Curve



Typical Performance Characteristics (Continued)

Figure 7. Reverse Recovery Charge 2500 Reverse Recovery Charge, Qrr[nC] _ = 30A T_C = 175°C 2000 1500 T_C = 125°C 1000 $T_C = 25^{\circ}C$ 500 0 C 100

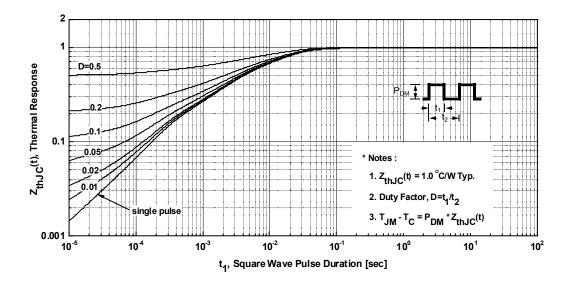
Figure 8. Transient Thermal Response Curve

300

di/dt [A/μs]

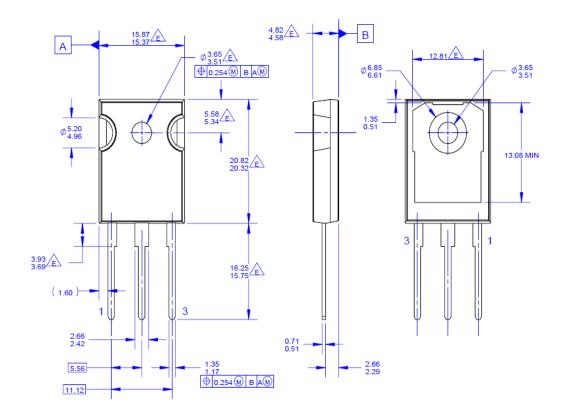
500

200



Mechanical Dimensions

TO-247-3L



Dimensions in Millimeters





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Rev. 166

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